FAIRCHILD

SEMICONDUCTOR TM

FDS9431A P-Channel 2.5V Specified MOSFET

General Description

This P-Channel 2.5V specified MOSFET is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

Applications

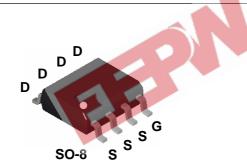
- DC/DC converter
- Power management
- Load switch
- Battery protection

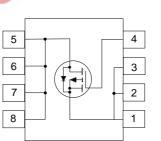
September 1999

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Features

- -3.5 A, -20 V. $R_{DS(ON)} = 0.130 \ \Omega \ @ V_{GS} = -4.5 \ V$ $R_{DS(ON)} = 0.180 \ \Omega \ @ V_{GS} = -2.5 \ V.$
- Fast switching speed.
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability.





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
ID	Drain Current - Continuous	(Note 1a)	-3.5	A
	- Pulsed		-18	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1.0	
TJ, T _{stg}	Operating and Storage Junction Temperat	ture Range	-55 to +150	°C

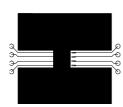
Thermal Characteristics

R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

-	Device Marking	Device Marking Device		Tape width	Quantity	
'	FDS9431A	FDS9431A	13"	12mm	2500 units	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Cha	acteristics			ļ	ļ	ļ
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-20			V
<u>ΔBVdss</u> ΔTJ	Breakdown Voltage Temperature Coefficient	I_D = -250 µA,Referenced to 25°C		-28		mV/°(
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$			-1	μA
IGSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 8 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.6	-1	V
<u>ΔVgs(th)</u> ΔTJ	Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA,Referenced to 25°C		2		mV/°(
R _{DS(on)}	Static Drain-Source	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.5 \text{ A}$		0.110	0.130	Ω
	On-Resistance	$V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$ $V_{GS} = -4.5 \text{ V}, I_D = -3.5 \text{ A}$	a	0.140 0.155	0.180	Ω
		T _J =125°C	1	0.155	0.220	Ω
I _{D(on)}	On-State Drain Current	V _{GS} = -4.5 V, V _{DS} =-5 V	-10			Α
g fs	Forward Transconductance	V _{DS} = -5 V, I _D = -3.5 A		6.5		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 V, V_{GS} = 0 V,$		405		pF
Coss	Output Capacitance	f = 1.0 MHz		170		pF
Crss	Reverse Transfer Capacitance			45		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = -5 V, I_D = -1 A,$		6.5	13	ns
tr	Turn-On Rise Time	$V_{\rm GS} = -4.5 \text{V}, \text{R}_{\rm GEN} = 6 \Omega$		20	35	ns
t _{d(off)}	Turn-Off Delay Time			31	50	ns
t _f	Turn-Off Fall Time	-		21	35	ns
Qg	Total Gate Charge	V _{DS} = -5 V, I _D = -3.5 A,		6	8.5	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -4.5 V		0.8		nC
Q _{gd}	Gate-Drain Charge	1		1.3		nC
Drain-94	Durce Diode Characteristics	and Maximum Patings	ļ	ļ	ļ	ļ
ls	Maximum Continuous Drain-Source				-2.1	A
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-0.7	-1.2	V

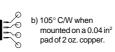


Scale 1:1 on letter size paper

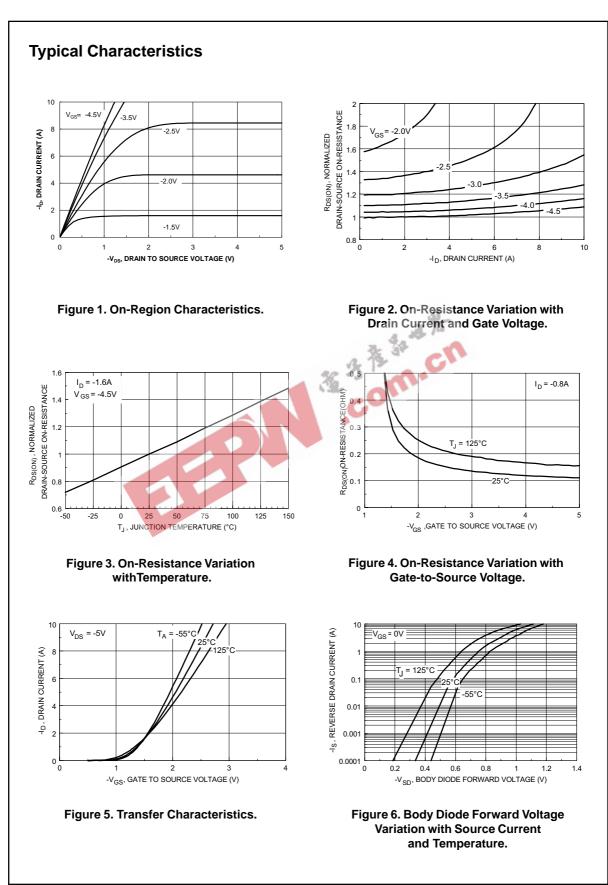
2: Pulse Test: Pulse Width \leq 300 $\mu s,$ Duty Cycle \leq 2.0%



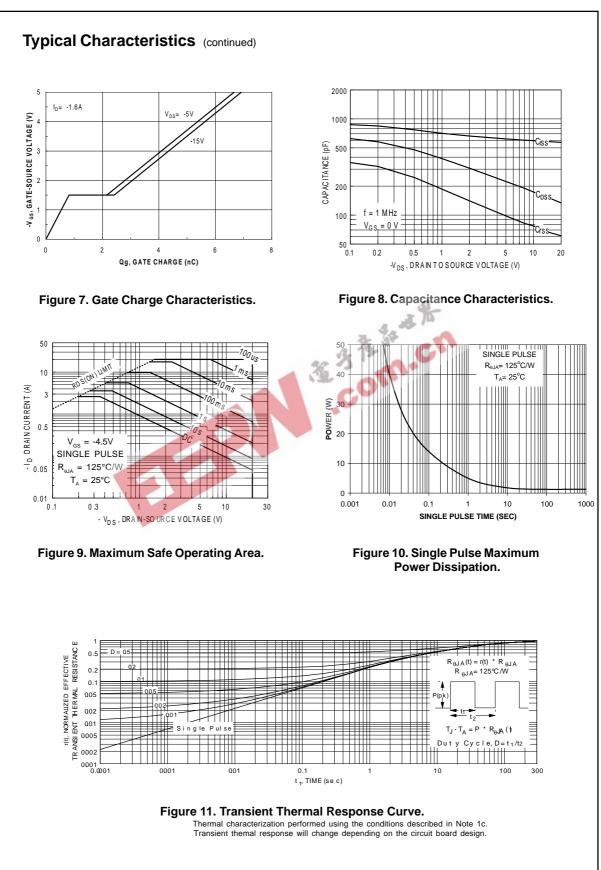




c) 125° C/W on a minimum mounting pad. FDS9431A



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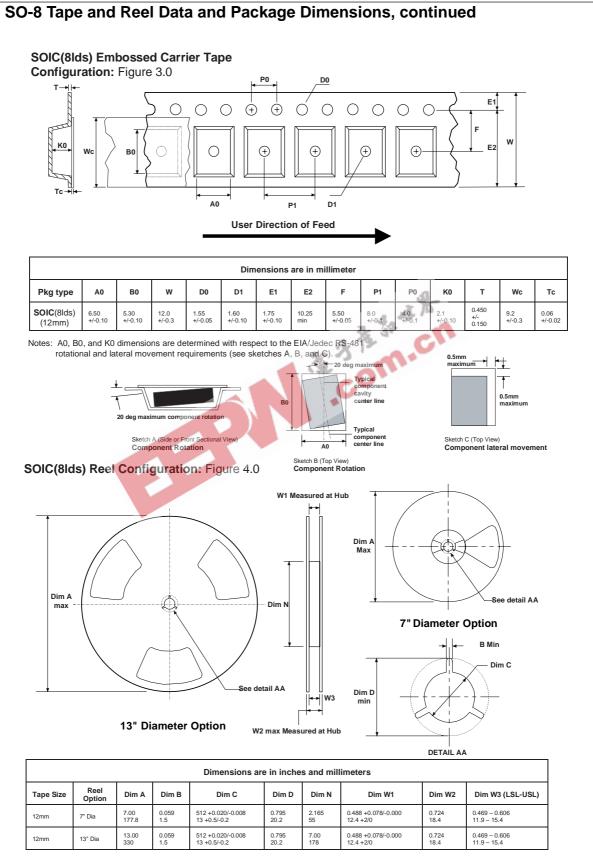


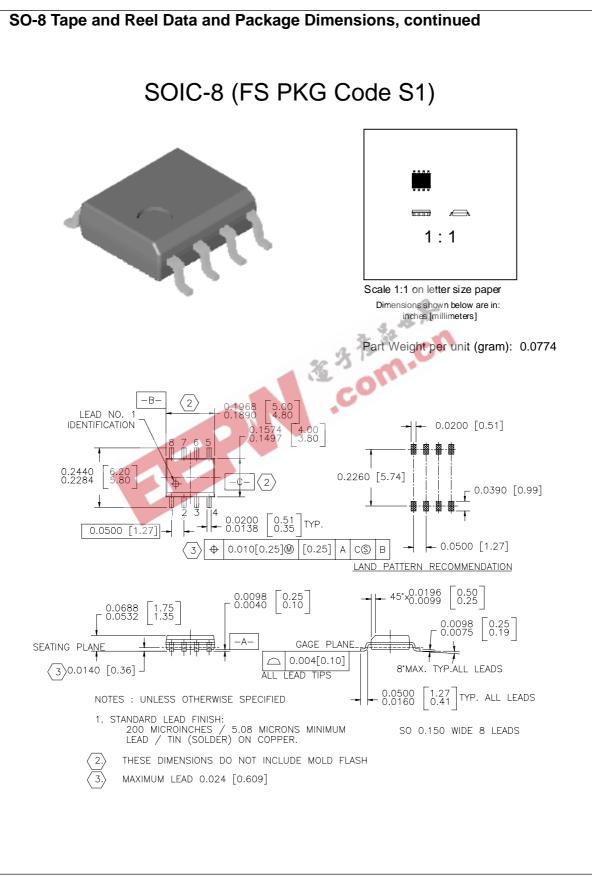
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July 1999, Rev. B





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E²CMOS™	PowerTrench™	
FACT™	QS™	
FACT Quiet Series™	Quiet Series [™]	
FAST®	SuperSOT™-3	
FASTr™	SuperSOT™-6	
GTO™	SuperSOT™-8	
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